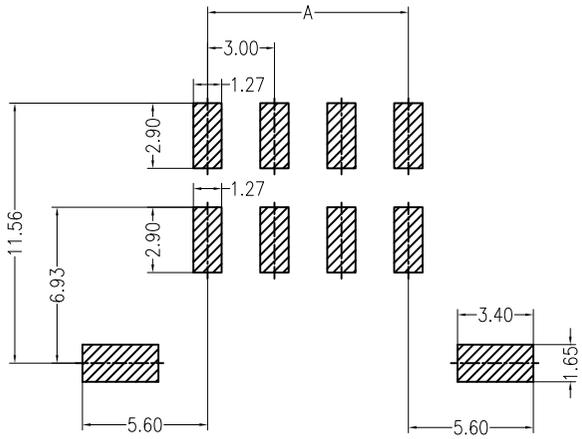
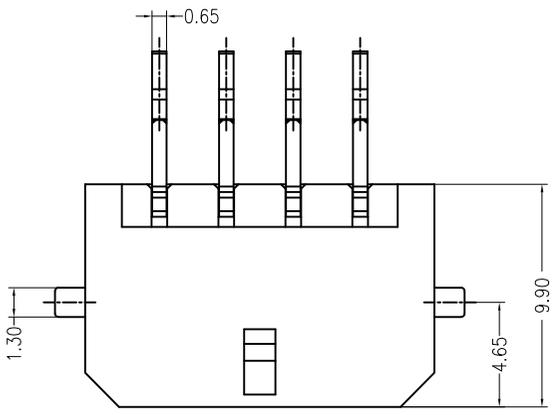
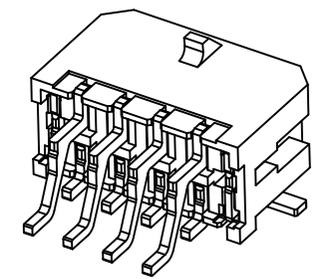


REV	DESCRIPTION	DESIGN	DATE
A0			



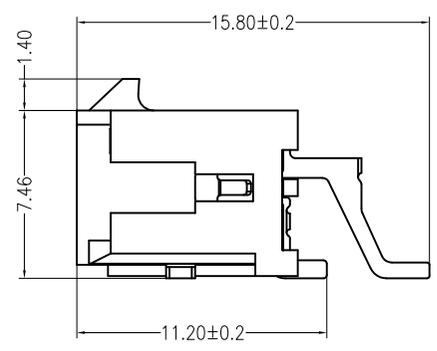
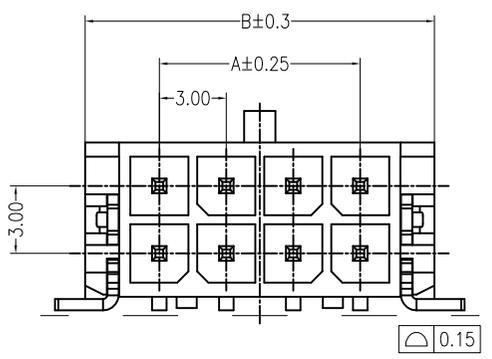
PCB LAYOUT(Tolerance:±0.05)



PIN	DIM A	DIM B
2x2	3.00	9.65
2x3	6.00	12.65
2x4	9.00	15.65
2x5	12.00	18.65
2x6	15.00	21.65
2x7	18.00	24.65
2x8	21.00	27.65
2x9	24.00	30.65
2x10	27.00	33.65
2x11	30.00	36.65
2x12	33.00	39.65

Specifications:

- Contact resistance: ≤10mΩ
- Insulation resistance: ≥1000MΩ
- Rated voltage: 250V AC DC
- Rated current: 5.0A AC DC
- Withstand Voltage: 1000V AC/minute
- Temperature Range: -25°C ~ +85°C
- Housing: LCP UL94V-0, BLACK
- Contacts: Brass/MATTE Sn-plated
- Solder Tabs: Brass/MATTE Sn-plated

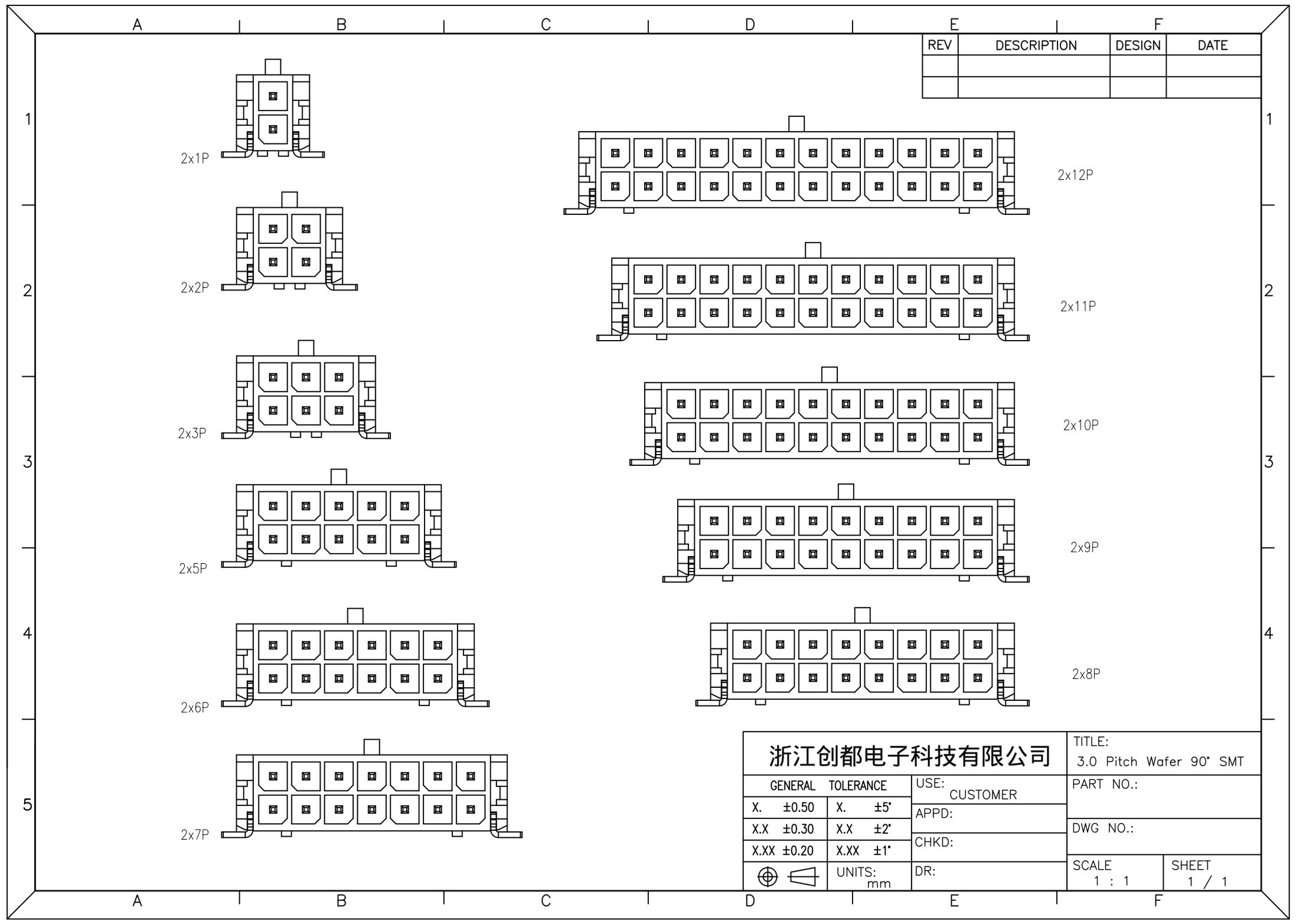


ORDER INFORMATION:

A3001AWR-2-F9KB3-R**

PART No.:		PACKAGING:	R=REEL
No.OF CIRCUITS:		Metal code:	3=Brass
PLASTIC MATERIAL:	F9K=LCP	PLATING:	B=MATTE Sn

浙江创都电子科技有限公司		TITLE:		3.0 Pitch Wafer 90° SMT	
		PART NO.:		MX3.0-2x*AWT	
GENERAL TOLERANCE		USE:		PART NO.:	
X. ±0.50	X. ±5°	CUSTOMER		DWG NO.:	
X.X ±0.30	X.X ±2°	APPD:		SCALE	
X.XX ±0.20	X.XX ±1°	CHKD:		1 : 1	
UNITS: mm		DR:		SHEET	
				1 / 1	



REV	DESCRIPTION	DESIGN	DATE

浙江创都电子科技有限公司		TITLE: 3.0 Pitch Wafer 90° SMT	
		PART NO.:	
GENERAL TOLERANCE		USE: CUSTOMER	
X. ±0.50	X. ±5°	APPD:	
X.X ±0.30	X.X ±2°	CHKD:	
X.XX ±0.20	X.XX ±1°	DR:	
UNITS: mm		SCALE 1 : 1	SHEET 1 / 1